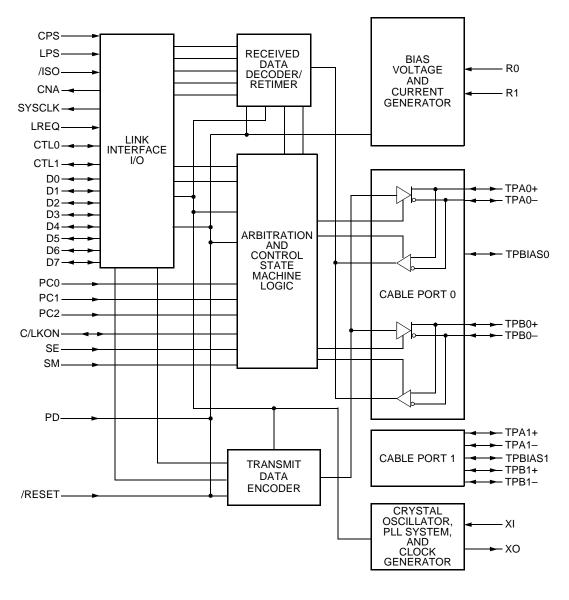
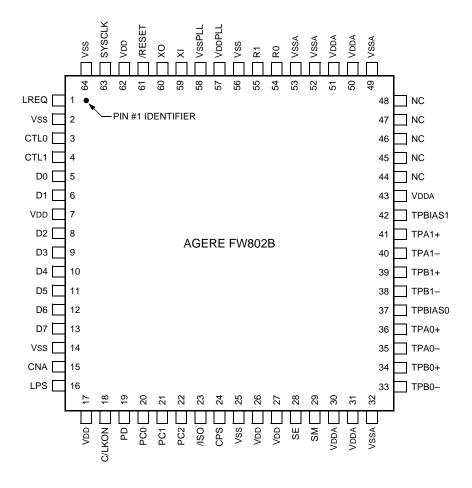
Description (continued)



5-5459.f (F)

Figure 1. Block Diagram

Signal Information



Note: Active-low signals are indicated by "/" at the beginning of signal names, within this document.

5-6236.b (F)

Figure 2. Pin Assignments

Table 1. Signal Descriptions

Pin	Signal*	Туре	Name/Description
18	C/LKON	I/O	Bus Manager Capable Input and Link-On Output. On hardware reset (/RESET), this pin is used to set the default value of the contender status indicated during self-ID. The bit value programming is done by tying the signal through a 10 k Ω resistor to VDD (high, bus manager capable) or to GND (low, not bus manager capable). Using either the pull-up or pull-down resistor allows the link-on output to override the input value when necessary.
			After hardware reset, this pin is set as an output. If the LPS is inactive, C/LKON indicates one of the following events by asserting a 6.114 MHz signal.
			 FW802B receives a link-on packet addressed to this node. Port_event register bit is 1. Any of the Timeout, Pwr_fail, or Loop register bits are 1 and the Watchdog register bit is also 1. Once activated, the C/LKON output will continue active until the LPS becomes active. The PHY also deasserts the C/LKON output when a 1394 bus reset occurs, if the C/LKON is active due solely to the reception of a link-on packet.
			Note: If an interrupt condition exists which would otherwise cause the C/LKON output to be activated if the LPS were inactive, the C/LKON output will be activated when the LPS subsequently becomes inactive.
15	CNA	0	Cable-Not-Active Output. CNA is asserted high when none of the PHY ports are receiving an incoming bias voltage. This circuit remains active during the powerdown mode.
24	CPS	I	Cable Power Status. CPS is normally connected to the cable power through a 400 kΩ resistor. This circuit drives an internal comparator that detects the presence of cable power. This information is maintained in one internal register and is available to the LLC by way of a register read (see Table 8, address register 00002, bit 7/PS). In applications that do not sink or source 1394 power (VP), this pin can be tied to ground.
			Note: When this pin is grounded, the Pwr_fail bit in PHY register 01012 will be set.
3	CTL0	I/O	Control I/O. The CTLn signals are bidirectional communications control signals between the PHY and the LLC. These signals control the passage
4	CTL1		of information between the two devices. Bus-keeper circuitry is built into these terminals.
5, 6, 8, 9, 10, 11, 12, 13	D[0:7]	I/O	Data I/O. The Dn signals are bidirectional and pass data between the PHY and the LLC. Bus-keeper circuitry is built into these terminals.

^{*} Active-low signals are indicated by "/" at the beginning of signal names, within this document.

Table 1. Signal Descriptions (continued)

Pin	Signal*	Туре	Name/Description
23	/ISO	I	Link Interface Isolation Disable Input (Active-Low). /ISO controls the operation of an internal pulse differentiating function used on the PHY-LLC interface signals, CTLn and Dn, when they operate as outputs. When /ISO is asserted low, the isolation barrier is implemented between PHY and its LLC (as described in Annex J of <i>IEEE 1394</i> -1995). /ISO is normally tied high to disable isolation differentiation. Bus-keepers are enabled when /ISO is high (inactive) on CTLn, Dn, and LREQ. When /ISO is low (active), the bus-keepers are disabled. Please refer to Agere's application note <i>IEEE 1394 Isolation</i> (AP98-074CMPR) for more information.
16	LPS	I	Link Power Status. LPS is connected to either the VDD supplying the LLC or to a pulsed output that is active when the LLC is powered for the purpose of monitoring the LLC power status. If LPS is inactive for more than 1.2 μ s and less than 25 μ s, the PHY-link interface is reset. If LPS is inactive for greater than 25 μ s, the PHY will disable the PHY/link interface to save power. FW802B continues its repeater function.
1	LREQ	I	Link Request. LREQ is an output from the LLC that requests the PHY to perform some service. Bus-keeper circuitry is built into this terminal.
44, 45, 46, 47, 48	NC	_	No Connect.
20	PC0	I	Power-Class Indicators. On hardware reset (/RESET), these inputs set
21 22	PC1 PC2		the default value of the power class indicated during SelfID. These bits can be tied to VDD (high) or to ground (low) as required for particular power consumption and source characteristics. In SelfID packet (see Section 4.3.4.1 of the <i>1394a-2000 Specification</i>), PC0, the most significant bit of this 3-bit field, corresponds to bit 20, PC1 corresponds to bit 21, and PC2 corresponds to bit 22. As an example, for a Power_Class value of 001, PC0 = 0, PC1 = 0, and PC2 = 1.
19	PD	I	Powerdown. When asserted high, PD turns off all internal circuitry except the bias-detect circuits that drive the CNA signal. Internal FW802B logic is kept in the reset state as long as PD is asserted. The PD terminal is provided for backward compatibility. It is recommended that the FW802B be allowed to manage its own power consumption using suspend/resume in conjunction with LPS. C/LKON features are defined in the <i>IEEE 1394</i> a-2000 specification.
57	VDDPLL	_	Power for PLL Circuit. VDDPLL supplies power to the PLL circuitry portion of the device.
58	VssPLL	_	Ground for PLL Circuit. VssPLL is tied to a low-impedance ground plane.
54	R0	I	Current Setting Resistor. An internal reference voltage is applied to a resistor connected between R0 and R1 to set the operating current and the cable driver output current. A low temperature-coefficient resistor
55	R1		(TCR) with a value of 2.49 k Ω ± 1% should be used to meet the <i>IEEE 1394</i> -1995 standard requirements for output voltage limits.

^{*} Active-low signals are indicated by "/" at the beginning of signal names, within this document.

Table 1. Signal Descriptions (continued)

Pin	Signal*	Туре	Name/Description
61	/RESET	I	Reset (Active-Low). When /RESET is asserted low (active), a 1394 bus reset condition is set on the active cable ports and the FW802B is reset to the reset start state. To guarantee that the PHY will reset, this pin must be held low for at least 2 ms. An internal pull-up resistor connected to VDD is provided so that only an external delay capacitor (0.1 μF) and resistor (510 $k\Omega$), in parallel, are required to connect this pin to ground. This circuitry will ensure that the capacitor will be discharged when PHY power is removed. This input is a standard logic buffer and can also be driven by an open-drain logic output buffer. Do not leave this pin unconnected.
28	SE	I	Test Mode Control. SE is used during Agere's manufacturing test and should be tied to Vss for normal operation.
29	SM	I	Test Mode Control. SM is used during Agere's manufacturing test and should be tied to Vss for normal operation.
63	SYSCLK	0	System Clock. SYSCLK provides a 49.152 MHz clock signal, which is synchronized with the data transfers to the LLC.
36	TPA0+	Analog I/O	Port0, Port Cable Pair A. TPA0± is the port A connection to the twisted-
35	TPA0-		pair cable. Board traces from each pair of positive and negative differential signal pins should be kept as short as possible and matched to the external load resistors and to the cable connector. When the FW802B's 1394 port pins are not wired to a connector, the unused port pins may be left unconnected. Internal connect-detect circuitry will keep the port in a disconnected state.
41	TPA1+	Analog I/O	Port1, Port Cable Pair A. TPA1± is the port A connection to the twisted-
40	TPA1-		pair cable. Board traces from each pair of positive and negative differential signal pins should be kept as short as possible and matched to the external load resistors and to the cable connector. When the FW802B's 1394 port pins are not wired to a connector, the unused port pins may be left unconnected. Internal connect-detect circuitry will keep the port in a disconnected state.
34	TPB0+	Analog I/O	Port0, Port Cable Pair B. TPB0± is the port B connection to the twisted-
33	TPB0-		pair cable. Board traces from each pair of positive and negative differential signal pins should be kept as short as possible and matched to the external load resistors and to the cable connector. When the FW802B's 1394 port pins are not wired to a connector, the unused port pins may be left unconnected. Internal connect-detect circuitry will keep the port in a disconnected state.
39	TPB1+	Analog I/O	Port1, Port Cable Pair B. TPB1± is the port B connection to the twisted-
38	TPB1-		pair cable. Board traces from each pair of positive and negative differential signal pins should be kept as short as possible and matched to the external load resistors and to the cable connector. When the FW802B's 1394 port pins are not wired to a connector, the unused port pins may be left unconnected. Internal connect-detect circuitry will keep the port in a disconnected state.

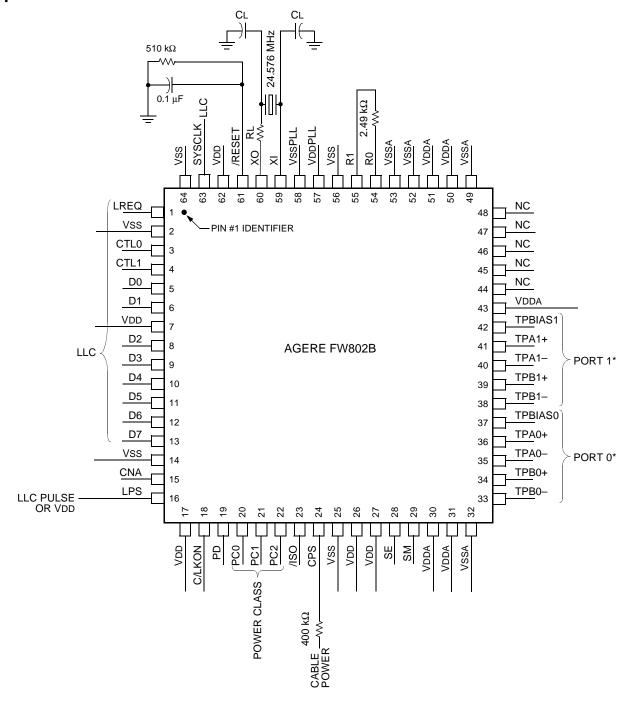
^{*} Active-low signals are indicated by "/" at the beginning of signal names, within this document.

Table 1. Signal Descriptions (continued)

Pin	Signal*	Туре	Name/Description
37	TPBIAS0	Analog I/O	Portn, Twisted-Pair Bias. (Where n refers to the port number). TPBIAS
42	TPBIAS1		provides the 1.86 V nominal bias voltage needed for proper operation of the twisted-pair cable drivers and receivers and for sending a valid cable connection signal to the remote nodes. When the FW802B's 1394 port pins are not wired to a connector, the unused port pins may be left unconnected. Internal connect-detect circuitry will keep the port in a disconnected state.
7, 17, 26, 27, 62	VDD	_	Digital Power. VDD supplies power to the digital portion of the device.
30, 31, 43, 50, 51	VDDA	_	Analog Circuit Power. VDDA supplies power to the analog portion of the device.
2, 14, 25, 56, 64	Vss	_	Digital Ground. All Vss signals should be tied to the low-impedance ground plane.
32, 49, 52, 53	Vssa	_	Analog Circuit Ground. All VSSA signals should be tied together to a low-impedance ground plane.
59	ΧI	_	Crystal Oscillator. XI and XO connect to a 24.576 MHz parallel resonant fundamental mode crystal. Although, when a 24.576 MHz clock source is used, it can be connected to XI with XO left unconnected. The optimum
60	ХО		values for the external load capacitors and resistor are dependent on the specifications of the crystal used. It is necessary to add an external series resistor (RL) to the XO pin (see Figures and solution). For more details, refer to the Crystal Selection Considerations section in the data sheet. Note that it is very important to place the crystal as close as possible to the XO and XI pins, i.e., within 0.5 in./1.27 cm.

 $^{^{\}star}$ Active-low signals are indicated by "/" at the beginning of signal names, within this document.

Application Information



5-6767 (F)

Figure 3. Typical External Component Connections

^{*} See Figure 4 for typical port termination network.

Application Information (continued)

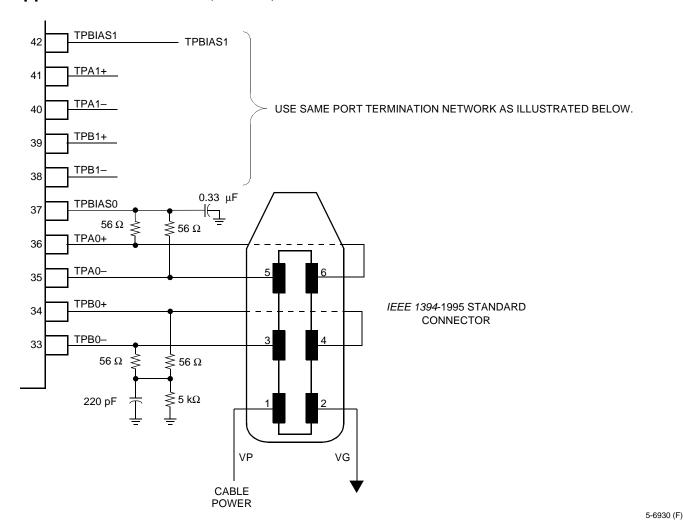


Figure 4. Typical Port Termination Network

Crystal Selection Considerations

The FW802B is designed to use an external 24.576 MHz parallel resonant fundamental mode crystal connected between the XI and XO terminals to provide the reference for an internal oscillator circuit. The *IEEE 1394*a-2000 standard requires that FW802B have less than ± 100 ppm total variation from the nominal data rate, which is directly influenced by the crystal. To achieve this, it is recommended that an oscillator with a nominal 50 ppm or less frequency tolerance be used.

The total frequency variation must be kept below ± 100 ppm from nominal with some allowance for error introduced by board and device variations. Trade offs between frequency tolerance and stability may be made as long as the total frequency variation is less than ± 100 ppm.

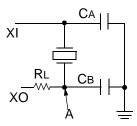
Crystal Selection Considerations (continued)

Load Capacitance

The frequency of oscillation is dependent upon the load capacitance specified for the crystal, in parallel resonant mode crystal circuits. Total load capacitance (CL) is a function of not only the discrete load capacitors, but also capacitances from the FW802B board traces and capacitances of the other FW802B connected components.

The values for load capacitors (CA and CB) should be calculated using this formula:

$$CA = CB = (CL - Cstray) \times 2$$



Where:

CL = load capacitance specified by the crystal manufacturer

Cstray = capacitance of the board and the FW802B, typically 2 pF-3 pF

RL = load resistance; the value of RL is dependent on the specific crystal used. Please refer to your crystal manufacturer's data sheet and application notes to determine an appropriate value.

Figure 5. Crystal Circuitry

Adjustment to Crystal Loading

The resistor (RL) in Figure 5 is recommended for fine-tuning the crystal circuit. The value for this resistor is dependent on the specific crystal used. Please refer to your crystal manufacturer's data sheet and application notes to determine an appropriate value for RL. A more precise value for this resistor can be obtained by placing different values of RL on a production board and using an oscilloscope to view the resultant clock waveform at node A for each resistor value. The desired waveform should have the following characteristics: the waveform should be sinusoidal, with an amplitude as large as possible, but not greater than 3.3 V or less than 0 volts.

Crystal/Board Layout

The layout of the crystal portion of the PHY circuit is important for obtaining the correct frequency and minimizing noise introduced into the FW802B PLL. The crystal and two load capacitors (CA + CB) should be considered as a unit during layout. They should be placed as close as possible to one another, while minimizing the loop area created by the combination of the three components. Minimizing the loop area minimizes the effect of the resonant current that flows in this resonant circuit. This layout unit (crystal and load capacitors) should then be placed as close as possible to the PHY XI and XO terminals to minimize trace lengths. Vias should not be used to route the XI and XO signals.

1394 Application Support Contact Information

E-mail: support1394@agere.com

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage Range	Vdd	3.0	3.6	V
Input Voltage Range*	Vı	-0.5	VDD + 0.5	V
Output Voltage Range at Any Output	Vo	-0.5	VDD + 0.5	V
Operating Free Air Temperature	TA	0	70	°C
Storage Temperature Range	Tstg	– 65	150	°C

^{*} Except for 5 V tolerant I/O (CTL0, CTL1, D0—D7, and LREQ) where VI $\max = 5.5 \text{ V}$.

Electrical Characteristics

Table 3. Analog Characteristics

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Supply Voltage	Source power node	VDD—SP	3.0	3.3	3.6	V
Differential Input Voltage	Cable inputs, 100 Mbits/s operation	VID—100	142		260	mV
	Cable inputs, 200 Mbits/s operation	VID-200	132	_	260	mV
	Cable inputs, 400 Mbits/s operation	VID-400	100	_	260	mV
	Cable inputs, during arbitration	VID—ARB	168	_	265	mV
Common-mode Voltage	TPB cable inputs,	Vсм	1.165	_	2.515	V
Source Power Mode	speed signaling off					
	TPB cable inputs,	VCM—SP—100	1.165		2.515	٧
	S100 speed signaling on	1/01/ 07 000	0.005		0.545	
	TPB cable inputs, S200 speed signaling on	VCM—SP—200	0.935	_	2.515	V
	TPB cable inputs,	VCM—SP—400	0.532		2.515	V
	S400 speed signaling on	V CIVI—3F—400	0.552		2.515	v
Common-mode Voltage	TPB cable inputs,	Vсм	1.165	_	2.015	V
Nonsource Power Mode*	speed signaling off					
	TPB cable inputs,	VCM—NSP—100	1.165	_	2.015	V
	S100 speed signaling on					
	TPB cable inputs,	VCM—NSP—200	0.935	_	2.015	V
	S200 speed signaling on					
	TPB cable inputs,	VCM—NSP—400	0.532	_	2.015	V
Deseive lanut litter	S400 speed signaling on TPA, TPB cable inputs,				4.00	
Receive Input Jitter	100 Mbits/s operation	_		_	1.08	ns
	TPA, TPB cable inputs,	_			0.5	ns
	200 Mbits/s operation				0.0	110
	TPA, TPB cable inputs,	_	_	_	0.315	ns
	400 Mbits/s operation					
Receive Input Skew	Between TPA and TPB cable inputs,	_		_	0.8	ns
	100 Mbits/s operation					
	Between TPA and TPB cable inputs,	_	_	_	0.55	ns
	200 Mbits/s operation				0.5	
	Between TPA and TPB cable inputs, 400 Mbits/s operation	_	_	_	0.5	ns
Positive Arbitration	— —	VTH+	89		168	mV
Comparator Input		VIIIT	03		100	IIIV
Threshold Voltage						
Negative Arbitration	_	VTH-	-168	_	-89	mV
Comparator Input						
Threshold Voltage						
Speed Signal Input	200 Mbits/s	VTH—S200	45	_	139	mV
Threshold Voltage	400 Mbits/s	VTH—S400	266	_	445	mV
Output Current	TPBIAS outputs	lo	- 5	_	2.5	mA
TPBIAS Output Voltage	At rated I/O current	Vo	1.665	_	2.015	V
Current Source for	-	ICD	_	_	76	μΑ
Connect Detect Circuit						

^{*} For a node that does not source power (see Section 4.2.2.2 in *IEEE 1394*-1995 Standard).

Electrical Characteristics (continued)

Table 4. Driver Characteristics

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Differential Output Voltage	56 Ω load	Vod	172	_	265	mV
Off-state Common-mode Voltage	Drivers disabled	Voff	_	_	20	mV
Driver Differential Current, TPA+, TPA-, TPB+, TPB-	Driver enabled, speed signaling off*	IDIFF	-1.05	_	1.05	mA
Common-mode Speed Signaling Current, TPB+, TPB-	200 Mbits/s speed signaling enabled [†]	ISP	-2.53	_	-4.84	mA
	400 Mbits/s speed signaling enabled [†]	ISP	-8.1	_	-12.4	mA

^{*} Limits are defined as the algebraic sum of TPA+ and TPA- driver currents. Limits also apply to TPB+ and TPB- as the algebraic sum of driver currents.

[†] Limits are defined as the absolute limit of each of TPB+ and TPB- driver currents.

Electrical Characteristics (continued)

Table 5. Device Characteristics

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Supply Current: One Port Active All Ports Active No Ports Active, (Microlow- power Sleep Mode) LPS = 0	VDD = 3.3 V	IDD IDD IDD		54 74 50	_ _ _	mA mA μA
PD = 1		IDD	_	50	_	μΑ
High-level Output Voltage	Iон max, VDD = min	Voн	VDD - 0.4	_	_	V
Low-level Output Voltage	IOL min, VDD = max	Vol	_		0.4	V
High-level Input Voltage	CMOS inputs	VIH	0.7 Vdd		_	V
Low-level Input Voltage	CMOS inputs	VIL	_	_	0.2 VDD	V
Pull-up Current, /RESET Input	VI = 0 V	lı	11	_	32	μΑ
Powerup Reset Time, /RESET Input	VI = 0 V	_	2	_	_	ms
Rising Input Threshold Voltage /RESET Input	_	VIRST	1.1	_	1.4	V
Output Current	SYSCLK	lol/loн @ TTL	-16	_	16	mA
	Control, data	IOL/IOH @ CMOS	-12	_	12	mA
	CNA	loL/loh	-16	_	16	mΑ
	C/LKON	loL/loh	-2	_	2	mΑ
Input Current, LREQ, LPS, PD, SE, SM, PC[0:2] Inputs	VI = VDD or 0 V	lı	_	_	°±1	μΑ
Off-state Output Current, CTL[0:1], D[0:7], C/LKON I/Os	Vo = VDD or 0 V	loz	_	_	°±5	μΑ
Power Status Input Threshold Voltage, CPS Input	400 kΩ resistor	VTH	7.5	_	8.5	V
Rising Input Threshold Voltage*, LREQ, CTLn, Dn	_	VIT+	VDD/2 + 0.3	_	VDD/2 + 0.8	V
Falling Input Threshold Voltage*, LREQ, CTLn, Dn	_	VIT-	VDD/2 - 0.8	_	VDD/2 - 0.3	V
Bus Holding Current, LREQ, CTLn, Dn	VI = 1/2(VDD)	_	250	_	550	μΑ
Rising Input Threshold Voltage LPS	_	VLIH	_	_	0.24 VDD + 1	V
Falling Input Threshold Voltage LPS	_	VLIL	0.24 VDD + 0.2	_	_	V

^{*} Device is capable of both differentiated and undifferentiated operation.

Timing Characteristics

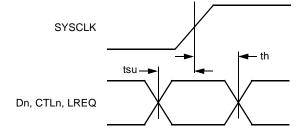
Table 6. Switching Characteristics

Symbol	Parameter	Measured	Test Conditions	Min	Тур	Max	Unit
_	Jitter, Transmit	TPA, TPB	_	_	_	0.15	ns
_	Transmit Skew	Between TPA and TPB	_	_	_	±0.1	ns
tr	Rise Time, Transmit (TPA/TPB)	10% to 90%	Rι = 56 Ω, Cι = 10 pF	_	_	1.2	ns
tf	Fall Time, Transmit (TPA/TPB)	90% to 10%	RI = 56 Ω, CI = 10 pF	_	_	1.2	ns
tsu	Setup Time, Dn, CTLn, LREQ↑↓ to SYSCLK↑	50% to 50%	See Figure 6.	6	_	_	ns
th	Hold Time, Dn, CTLn, LREQ↑↓ from SYSCLK↑	50% to 50%	See Figure 6.	0	_	_	ns
td	Delay Time, SYSCLK↑ to Dn, CTLn↑↓	50% to 50%	See Figure 7.	1	_	6	ns

Table 7. Clock Characteristics

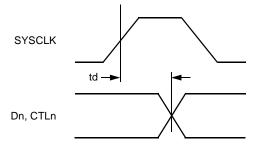
Parameter	Symbol	Min	Тур	Max	Unit
External Clock Source Frequency	f	24.5735	24.5760	24.5785	MHz

Timing Waveforms



5-6017.a (F)

Figure 6. Dn, CTLn, and LREQ Input Setup and Hold Times Waveforms



5-6018.a (F)

Figure 7. Dn, CTLn Output Delay Relative to SYSCLK Waveforms

Internal Register Configuration

The PHY register map is shown below in Table 8. (Refer to IEEE 1394a-2000, 5B.1 for more information).

Table 8. PHY Register Map for the Cable Environment

Address		Contents						
	Bit 0	Bit 1	Bit 2	Bit 3	Bit 4	Bit 5	Bit 6	Bit 7
00002			Physic	al_ID			R	PS
00012	RHB	IBR			Gap	_count		
00102	E	xtended (7)		XXXXX		Tota	l_ports	
00112		Max_speed		XXXXX		D	elay	
01002	LCtrl	Contender		Jitter			Pwr_class	
01012	Watchdog	ISBR	Loop	Pwr_fail	Timeout	Port_event	Enab_accel	Enab_multi
01102	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
01112	F	Page_select		XXXXX		Port _.	_select	
10002				Register (Page_select			
•	<u>.</u>							:
11112	Register 7 Page_select							
		٦			Ī			
		REQUIRED)	XXXXX	RESERVE)		

The meaning of the register fields within the PHY register map are defined by Table 9 below. Power reset values not specified are resolved by the operation of the PHY state machines subsequent to a power reset.

Table 9. PHY Register Fields for the Cable Environment

Field	Size	Туре	Power Reset Value	Description
Physical_ID	6	r	000000	The address of this node determined during self-identification. A value of 63 indicates a malconfigured bus; the link will not transmit any packets.
R	1	r	0	When set to one, indicates that this node is the root.
PS	1	r		Cable power active.
RHB	1	rw	0	Root Hold-off Bit. When set to one, the force_root variable is TRUE, which instructs the PHY to attempt to become the root during the next tree identify process.
IBR	1	rw	0	Initiate Bus Reset. When set to one, instructs the PHY to set ibr TRUE and reset_time to RESET_TIME. These values in turn cause the PHY to initiate a bus reset without arbitration; the reset signal is asserted for 166 µs. This bit is self-clearing.
Gap_count	6	rw	3F16	Used to configure the arbitration timer setting in order to optimize gap times according to the topology of the bus. See Section 4.3.6 of <i>IEEE</i> Standard <i>1394a</i> -2000 for the encoding of this field.
Extended	3	r	7	This field has a constant value of seven, which indicates the extended PHY register map.

Table 9. PHY Register Fields for the Cable Environment (continued)

Field	Size	Туре	Power Reset Value	Description	
Total_ports	4	r	2	The number of ports implemented by this PHY. This count reflects the number.	
Max_speed	3	r	0102	Indicates the speed(s) this PHY supports: 0002 = 98.304 Mbits/s 0012 = 98.304 and 196.608 Mbits/s 0102 = 98.304, 196.608, and 393.216 Mbits/s 0112 = 98.304, 196.608, 393.216, and 786.43 Mbits/s 1002 = 98.304, 196.608, 393.216, 786.432, and 1,572.864 Mbits/s 1012 = 98.304, 196.608, 393.216, 786.432, 1,572.864, and 3,145.728 Mbits/s All other values are reserved for future definition.	
Delay	4	r	0000	Worst-case repeater delay, expressed as 144 + (delay * 20) ns.	
LCtrl	1	rw	1	Link Active. Cleared or set by software to control the value of the L bit transmitted in the node's self-ID packet 0, which will be the logical AND of this bit and LPS active.	
Contender	1	rw	See description.	Cleared or set by software to control the value of the C bit transmitted in the self-ID packet. Powerup reset value is set I C/LKON pin.	
Jitter	3	r	000	The difference between the fastest and slowest repeater data delay, expressed as (jitter + 1) * 20 ns.	
Pwr_class	3	rw	See description.	Power-Class. Controls the value of the pwr field transmitted in the self-ID packet. See Section 4.3.4.1 of <i>IEEE</i> Standard 1394a-2000 for the encoding of this field. PC0, PC1, and PC2 pins set up power reset value.	
Watchdog	1	rw	0	When set to one, the PHY will set Port_event to one if resume operations commence for any port.	
ISBR	1	rw	0	Initiate Short (Arbitrated) Bus Reset. A write of one to this bit instructs the PHY to set ISBR true and reset_time to SHORT_RESET_TIME. These values in turn cause the PHY to arbitrate and issue a short bus reset. This bit is self-clearing.	
Loop	1	rw	0	Loop Detect. A write of one to this bit clears it to zero.	
Pwr_fail	1	rw	1	Cable Power Failure Detect. Set to one when the PS bit changes from one to zero. A write of one to this bit clears it to zero.	
Timeout	1	rw	0	Arbitration State Machine Timeout. A write of one to this bit clears it to zero (see MAX_ARB_STATE_TIME).	
Port_event	1	rw	0	Port Event Detect. The PHY sets this bit to one if any of connected, bias, disabled, or fault change for a port whose Int_enable bit is one. The PHY also sets this bit to one if resume operations commence for any port and Watchdog is one. A write of one to this bit clears it to zero.	

Table 9. PHY Register Fields for the Cable Environment (continued)

Field	Size	Туре	Power Reset Value	Description
Enab_accel	1	rw	0	Enable Arbitration Acceleration. When set to one, the PHY will use the enhancements specified in Section 4.4 of 1394a-2000 specification. PHY behavior is unspecified if the value of Enab_accel is changed while a bus request is pending.
Enab_multi	1	rw	0	Enable Multispeed Packet Concatenation. When set to one, the link will signal the speed of all packets to the PHY.
Page_select	3	rw	000	Selects which of eight possible PHY register pages are accessible through the window at PHY register addresses 10002 through 11112, inclusive.
Port_select	4	rw	000	If the page selected by Page_select presents per-port information, this field selects which port's registers are accessible through the window at PHY register addresses 10002 through 11112, inclusive. Ports are numbered monotonically starting at zero, p0.

The port status page is used to access configuration and status information for each of the PHY's ports. The port is selected by writing zero to Page_select and the desired port number to Port_select in the PHY register at address 01112. The format of the port status page is illustrated by Table 10 below; reserved fields are shown shaded. The meanings of the register fields with the port status page are defined by Table 11.

Table 10. PHY Register Page 0: Port Status Page

Address				Contents				
	Bit 0	Bit 1	Bit 2	Bit 3	Bit 4	Bit 5	Bit 6	Bit 7
10002	ASt	at	BStat		Child	Connected	Bias	Disabled
10012	Neg	otiated_spe	ed	Int_enable	Fault	XXXXX	XXXXX	XXXXX
10102	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
10112	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
11002	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
11012	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
11102	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
11112	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
	REQUIRED		1	XXXXX	RESERVE)		

The meaning of the register fields with the port status page are defined by Table 11 below.

Table 11. PHY Register Port Status Page Fields

Field	Size	Туре	Power Reset Value	Description	
AStat	2	r	TPA line state for the port: 002 = invalid 012 = 1 102 = 0 112 = Z		
BStat	2	r	_	TPB line state for the port (same encoding as AStat).	
Child	1	r	0	If equal to one, the port is a child; otherwise, a parent. The meaning of this bit is undefined from the time a bus reset is detected until the PHY transitions to state T1: Child Handshake during the tree identify process (see Section 4.4.2.2 in IEEE Standard 1394-1995).	
Connected	1	r	0	If equal to one, the port is connected.	
Bias	1	r	0	If equal to one, incoming TPBIAS is detected.	
Disabled	1	rw	0	If equal to one, the port is disabled.	
Negotiated_speed	3	r	000	Indicates the maximum speed negotiated between this PH port and its immediately connected port; the encoding is th same as for the PHY register Max_speed field.	
Int_enable	1	rw	0	Enable Port Event Interrupts. When set to one, the PHY will set Port_event to one if any of connected, bias, disabled, or fault (for this port) change state.	
Fault	1	rw	0	Set to one if an error is detected during a suspend or resume operation. A write of one to this bit clears it to zero.	

The vendor identification page is used to identify the PHY's vendor and compliance level. The page is selected by writing one to Page_select in the PHY register at address 01112. The format of the vendor identification page is shown in Table 12; reserved fields are shown shaded.

Table 12. PHY Register Page 1: Vendor Identification Page

Address				Contents				
	Bit 0	Bit 1	Bit 2	Bit 3	Bit 4	Bit 5	Bit 6	Bit 7
10002				Complia	nce_level			
10012	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX
10102								
10112				Vend	or_ID			
11002								
11012								
11102				Produ	uct_ID			
11112								
		REQUIRED	•	XXXXX	RESERVE)		

The meaning of the register fields within the vendor identification page are defined by Table 13.

Table 13. PHY Register Vendor Identification Page Fields

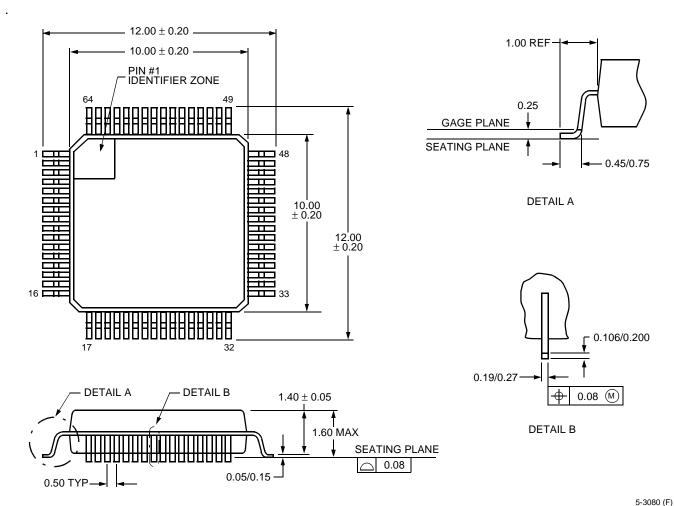
Field	Size	Туре	Description	
Compliance_level	8	r	Standard to which the PHY implementation complies: 0 = not specified 1 = IEEE 1394a-2000 Agere's FW802B compliance level is 1. All other values reserved for future standardization.	
Vendor_ID	24	r	The company ID or organizationally unique identifier (OUI) of the manufacturer of the PHY. Agere's vendor ID is 00601D16. This number is obtained from the <i>IEEE</i> registration authority committee (RAC). The most significant byte of Vendor_ID appears at PHY register location 10102 and the least significant at 11002.	
Product_ID	24	r	The meaning of this number is determined by the company or organization that has been granted Vendor_ID. Agere's FW802B product ID is 08020116. The most significant byte of Product_ID appears at PHY register location 11012 and the least significant at 11112.	

The vendor-dependent page provides access to information used in manufacturing test of the FW802B.

Outline Diagrams

64-Pin TQFP

Dimensions are in millimeters



0 0000 (1)

Ordering Information

Device Code	Package	Comcode		
FW802B-DB	64-Pin TQFP	700032322		
L-FW802B-DB	64-Pin TQFP (lead-free)*	700067297		

^{*} In an effort to better serve its customers and the environment, Agere is switching to lead-free packaging on this product (no intentional addition of lead).